

HP Intel Core i7-9700 processor 3 GHz 12 MB Smart Cache Box

Brand : HP

Product name : Intel Core i7-9700

Product code: 7AD11AV

Intel Core i7-9700 Processor (12MB Cache, up to 4.7 GHz)

HP Intel Core i7-9700. Processor family: Intel® Core [™] i7, Processor socket: LGA 1151 (Socket H4), Processor lithography: 14 nm. Memory channels: Dual-channel, Maximum internal memory supported by processor: 128 GB, Memory types supported by processor: DDR4-SDRAM. On-board graphics card model: Intel® UHD Graphics 630, Maximum on-board graphics card memory: 64 GB, On-board graphics card base frequency: 350 MHz. PCI Express configurations: 1x16, 1x8+2x4, 2x8, Supported instruction sets: AVX 2.0, SSE4.1, SSE4.2, Scalability: 1S. Processor package size: 37.5 x 37.5 mm



Processor9th gen Intel® Core ™ i7FeaturesProcessor generation9th gen Intel® Core ™ i7Execute Disable Bit✓Processor model *i7-9700Idle States✓Processor base frequency *3 GHzThermal Monitoring Technologies✓Processor family *Intel® Core ™ i7Maximum number of PCI Express16Processor cores *8Maximum number of PCI Express3.0Processor socket *LGA 1151 (Socket H4)PCI Express slots version3.0Processor threads8Supported instruction setsAVX 2.0, SSSystem bus rate8 GT/sScalability15Processor cache12 MBThermal solution specificationPCG 2015CProcessor cache typeSmart CachePCI Express CEM revision3.0Processor cache type *BoxProcessor special featuresPCI Express CEM revision	SE4.1, SSE4.2
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Thermal Design Power (TDP) 65 W	
Processor special features	
Fackage type box	
Memory bandwidth supported by	
processor (max) 41,6 GB/s (Intel® HT Technology)	
Processor codename Coffee Lake Intel® Identity Protection Technology (Intel® IPT)	
Memory Intel® Turbo Boost Technology 2.0	
Maximum internal memory supported by processor 128 GB Intel® Quick Sync Video Technology 🗸	
Memory types supported by Intel® InTru™ 3D Technology ✓	
processor DDR4-SDRAM Intel® Clear Video HD Technology (Intel® CVT HD)	
processor Intel® AES New Instructions (Intel®	
Memory channels * Dual-channel Enbanced Intel SpeedStep	
ECC × Technology	
Graphics Intel Trusted Execution Technology 🗸	
On-board graphics card * V Intel® Memory Protection Extensions (Intel® MPX)	
Discrete graphics card * × Intel VT-x with Extended Page	
On-board graphics card model * Intel® UHD Graphics 630 Tables (EPT)	
Maximum on-board graphics card 64 GB Intel® Secure Key	
On-board graphics card base 350 MHz Intel TSX-NI 🗸	
frequency (SIPP)	
On-board graphics card dynamic frequency (max) 1200 MHz Intel® OS Guard	
Number of displays supported (on- board graphics) Intel Clear Video Technology	
On-board graphics card 4K supportIntel Software Guard Extensions (Intel SGX)	

Graphics		Processor special features	
On-board graphics card DirectX version	12.0	Intel 64	✓
On-board graphics card OpenGL version	4.5	Intel Virtualization Technology (VT- x)	1
On-board graphics card maximum	4096 x 2304 pixels	Intel Virtualization Technology for Directed I/O (VT-d)	✓
resolution (DisplayPort)		Intel [®] Optane [™] Memory Ready	1
On-board graphics card maximum resolution (eDP - Integrated Flat Panel)	4096 x 2304 pixels	Intel [®] Boot Guard	✓
		Intel® vPro [™] Platform Eligibility	1
On-board graphics card maximum resolution (HDMI)	4096 x 2304 pixels	Operational conditions	
On-board graphics card refresh rate at maximum resolution (DisplayPort)	60 Hz	Tjunction	100 °C
		Weight & dimensions	
On-board graphics card refresh rate at maximum resolution (eDP - Integrated Flat Panel)	60 Hz	Processor package size	37.5 x 37.5 mm
On-board graphics card refresh rate at maximum resolution (HDMI)	24 Hz		
On-board graphics card ID	0x3E98		
Discrete graphics card model *	Not available		

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